EVERLIGHT EVERLIGHT ELECTRONICS CO., LTD.

# **Technical Data Sheet**

# **Chip LED with Right Angle Lens**

### Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow

solder process.

- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

### Descriptions

- The 12-21 SMD taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications etc.

#### Applications

- Telecommunication: Indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.
- Indoor signboard use.

### **Device Selection Guide**

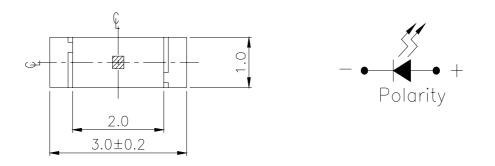
D. ANI		Lana Calan	
Part No.	Material	<b>Emitted</b> Color	Lens Color
12-21/BHC-YLMRY/2C	InGaN	Blue	Water Clear

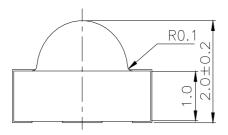


12-21/BHC-YLMRY/2C

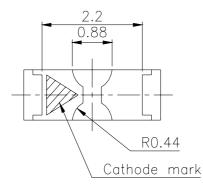


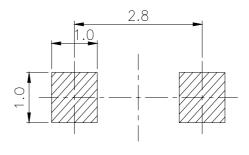
### **Package Outline Dimensions**











**Note:** The tolerances unless mentioned is  $\pm 0.1$  mm ,Unit = mm

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## <u>12-21/BHC-YLMRY/2C</u>

### Absolute Maximum Ratings (Ta=25°C)

	0 <						
	Parameter	Symbol	Rating	Unit			
	Reverse Voltage	Vr	5	V			
	Forward Current	IF	15	mA			
	Operating Temperature	Topr	$-40 \sim +85$	°C			
	Storage Temperature	Tstg	-40 ~ +90	°C			
	Electrostatic Discharge(HBM)	ESD	150	V			
	Power Dissipation	Pd	65	mW			
	Peak Forward Current (Duty 1/10 @1KHz)	Ifp	35	mA			
	Soldering Temperature	Tsol	Reflow Soldering : 260 $^{\circ}$ C for 10 s Hand Soldering : 350 $^{\circ}$ C for 3 sec.				
Ele	Electro-Optical Characteristics (Ta=25°C)						

Condition Symbol Min. Max. Unit Parameter Typ. Luminous Intensity 11.5 28.5  $I_V$ mcd -----Peak Wavelength  $\lambda_p$ ----468 ---nm Dominant 470 475  $\lambda_d$ ----nm Wavelength Spectrum Radiation I<sub>F</sub>=5mA 35  $\triangle \lambda$ --------Bandwidth nm  $2\theta 1/2$ Viewing Angle ----120 ---deg Forward Voltage  $V_{\rm F}$ V 2.5 3.1 \_\_\_\_  $V_R = 5V$ **Reverse Current** 50 IR μA --------

#### Notes:

1.Tolerance of Luminous Intensity: ±10%

- 2.Tolerance of Dominant Wavelength: ±1nm
- 3.Tolerance of Forward Voltage: ±0.05V

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## <u>12-21/BHC-YLMRY/2C</u>

#### **Bin Range Of Dom. Wavelength**

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Bin	Min	Max	Unit	Condition
Y	470	475	nm	I <sub>F</sub> =5mA

#### **Bin Range Of Luminous Intensity**

Bin	Min	Max	Unit	Condition
L	11.5	18.0	1	IF=5mA
М	18.0	28.5	mcd	

#### **Bin Range Of Forward Voltage**

Group	Bin	Min	Max	Unit	Condition
	9	2.50	2.70		
R	10	2.70	2.90	V	IF=5mA
	11	2.90	3.10		

Notes:

1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.05V

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## 12-21/BHC-YLMRY/2C

Ta=25°

3.8

10

10°

4.2

4.6

Ta=25°

10

Ta=25°

30°

40°

50°

60°

70°

80°

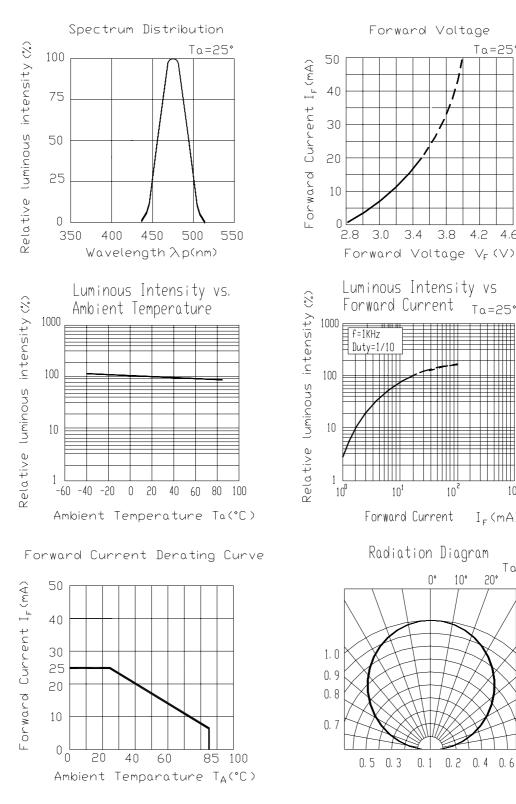
900

I<sub>F</sub>(mA)

20°

### **Typical Electro-Optical Characteristics Curves**

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0.4

0.6

0. 2

#### Label explanation

**CAT: Luminous Intensity Rank** 

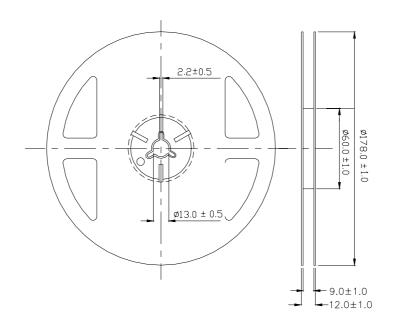
HUE: Dom. Wavelength Rank

**REF: Forward Voltage Rank** 



12-21/BHC-YLMRY/2C

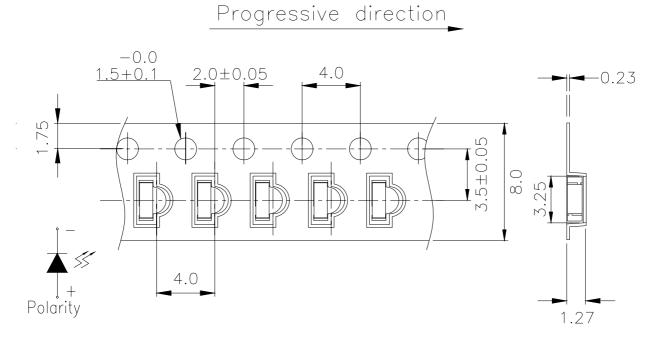
### **Reel Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

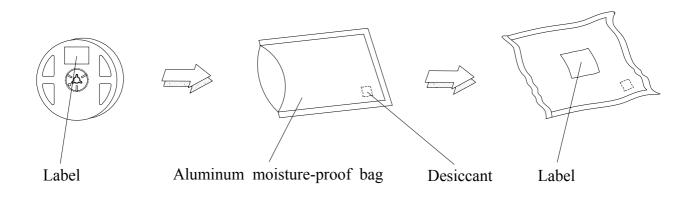
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## Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



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### **Moisture Resistant Packaging**



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### **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below. Confidence level : 90% LTPD : 10%

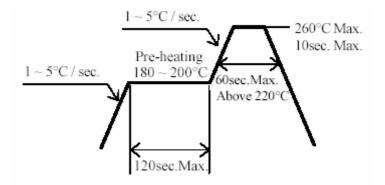
No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100°C 5min $\int 10 \sec$ L: -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/ 85%RH	1000 Hrs.	22 PCS.	0/1

### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen ).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
  - 2.2 Before opening the package: The LEDs should be kept at  $30^{\circ}$ C or less and 90%RH or less.
  - 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



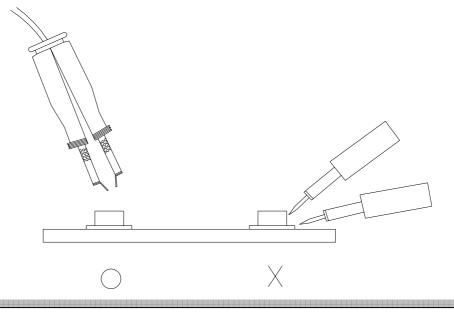
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

#### 4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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